

STPS30M120S

Power Schottky rectifier

Datasheet - production data

Features

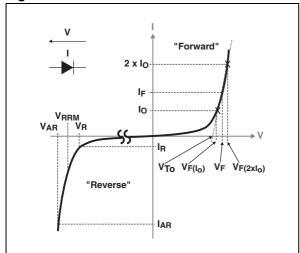
- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

This Schottky diode is suited for high frequency switch mode power supply.

Packaged in TO-220AB narrow leads and I²PAK, this device is intended to be used in notebook, game station and desktop adapters, providing in these applications a good efficiency at both low and high load.

Figure 1. Electrical characteristics^(a)



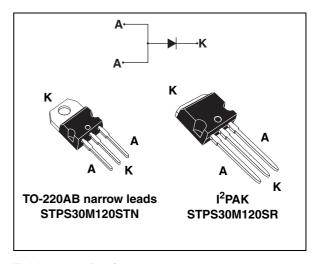


Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V_{RRM}	120 V
V _F (typ)	0.45 V
T _j (max)	150 °C

V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 9*. V_{AR} and I_{AR} are pulse measurements (t_p < 10 µs). V_R, I_R, V_{RRM} and V_F, are static characteristics

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1 Characteristics

Table 2. Absolute ratings (limiting values with terminals 1 and 3 short circuited at $T_{amb} = 25$ °C, unless otherwise specified)

Symbol		Value	Unit		
V _{RRM}	Repetitive peak reverse vo	oltage		120	V
I _{F(RMS)}	Forward rms current			50	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$ $T_c = 110 ^{\circ}C$			30	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sine-wave}$			260	Α
P _{ARM} ⁽¹⁾	Repetitive peak avalanche	eak avalanche power $T_j = 125$ °C, $t_p = 10 \mu s$			W
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	t _p < 10 μs, T _j	150	V	
V _{ASM} ⁽²⁾	Maximum single-pulse peak avalanche voltage	t _p < 10 μs, T _j	150	V	
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature ⁽³⁾			150	°C

For pulse time duration deratings, please refer to Figure 4. More details regarding the avalanche energy
measurements and diode validation in the avalanche are provided in the STMicroelectronics Application
notes AN1768, "Admissible avalanche power of schottky diodes" and AN2025, "Converter improvement
using Schottky rectifier avalanche specification".

- 2. See Figure 9
- 3. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.3	°C/W

Table 4. Static electrical characteristics (terminals 1 and 3 short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	V- - V	-	70	345	μΑ
'R`	current	$T_j = 125 ^{\circ}\text{C}$ $V_R = V_{RM}$	-	25	65	mA	
	V _F ⁽²⁾ Forward voltage drop	T _j = 125 °C	I _F = 5 A	-	0.45	0.50	
		T _j = 125 °C	I _F = 10 A	-	0.52	0.57	
V_(2)		T _j = 25 °C	I _F = 15 A	-		0.75	V
V F		T _j = 125 °C	IF = 13 A	-	0.57	0.62	V
		T _j = 25 °C	I _F = 30 A	-		0.90	
		T _j = 125 °C	1F - 30 A	-	0.66	0.73	

- 1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.53 \times I_{F(AV)} + 0.0067 \times I_{F^{2}(RMS)}$$

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Figure 2. Average forward power dissipation Figure 3. Average forward current versus versus average forward current ambient temperature ($\delta = 0.5$)

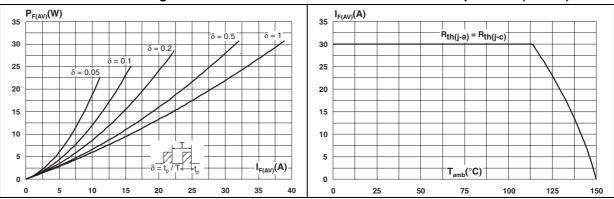


Figure 4. Normalized avalanche power derating versus pulse duration

Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

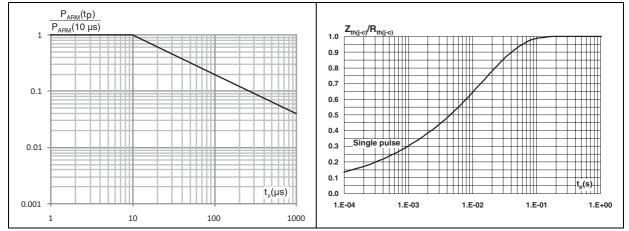
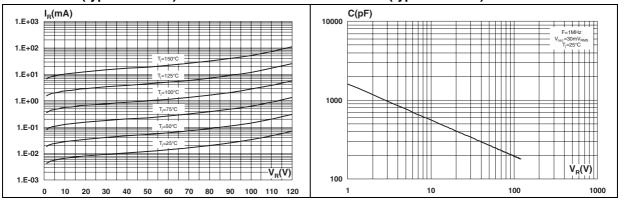


Figure 6. Reverse leakage current versus reverse voltage applied (typical values)

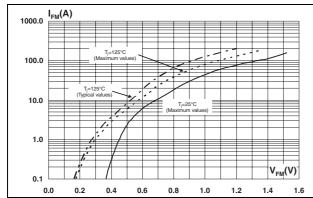
Figure 7. Junction capacitance versus reverse voltage applied (typical values)

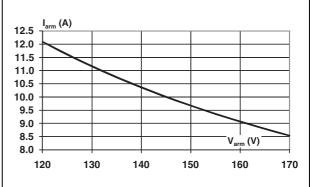


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Figure 8. Forward voltage drop versus forward current

Figure 9. Reverse safe operating area ($t_p < 10~\mu s$ and $T_j < 125~^{\circ}C$)





2 Package information

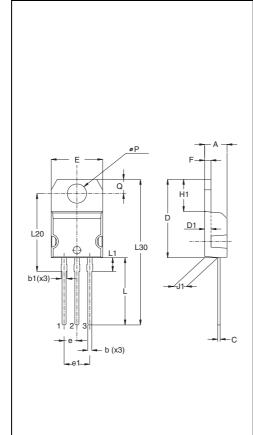
Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. TO-220AB narrow leads dimensions

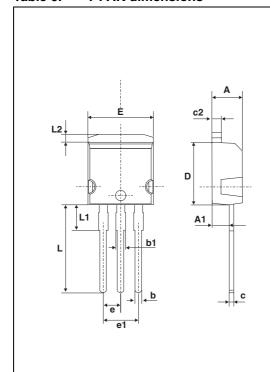


	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.17		0.18
b	0.61		0.88	0.024		0.034
b1	0.95		1.20	0.037		0.047
С	0.48		0.70	0.019		0.027
D	15.25		15.75	0.60		0.62
D1		1.27			0.05	
Е	10.00		10.40	0.39		0.41
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.19		0.20
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.24		0.26
J1	2.40		2.72	0.095		0.107
L	13.00		14.00	0.51		0.55
L1	2.60		2.90	0.102		0.114
L20	15.40			0.61		
L30		28.90			1.14	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116

Package information STPS30M120S

Devices in I²PAK with nickel-plated back frame must NOT be mounted by frame soldering like SMDs. Such devices are intended to be through-hole mounted ONLY and in no circumstances shall ST be held liable for any lack of performance or damage arising out of soldering of nickel-plated back frames.

Table 6. I²PAK dimensions



	Dimensions				
Ref.	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
A1	2.40	2.72	0.094	0.107	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.70	0.044	0.067	
С	0.49	0.70	0.019	0.028	
c2	1.23	1.32	0.048	0.052	
D	8.95	9.35	0.352	0.368	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.195	0.203	
Е	10	10.40	0.394	0.409	
L	13	14	0.512	0.551	
L1	3.50	3.93	0.138	0.155	
L2	1.27	1.40	0.050	0.055	

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30M120SR	PS30M120SR	I ² PAK	1.49 g	50	Tube
STPS30M120STN	PS30M120STN	TO-220AB narrow leads	1.9 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
02-Apr-2012	1	First issue.

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